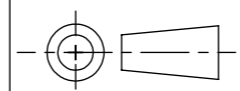


ISOMETRIC VIEW FOR REFERENCE

ITEM NUMBER	PART NUMBER	DESCRIPTION	QTY.
01	iW-PREPZ-MP-02-R3.0-REL1.1-HS001	SODIMM HEATSINK	01
02	LABEL	LABEL	01
03	TIM-23mm x 23mm	THERMAL PAD	01
04	TIM-8mm x 8mm	THERMAL PAD	01
05	M2 x6 X REC PAN HEAD SCREW	SCREW	04

DRAWN BY	GANGADHAR
CHECKED BY	GANGADHAR
APPROVED BY	IMMANUEL
THIS DRAWING SHEET IS PROPERITORY OF iWAVE SYSTEMS TECHNOLOGIES Pvt. Ltd.	
GENARALTOLERANCES :	
X: ± 0.25	
.X: ± 0.1	
.XX: ± 0.01	



iWave
Embedding Intelligence

iWave System Technologies Private Limited,
7/B, 29th Main, BTM Layout, 2nd Stage,
Bangalore-560076, India.

DRAWING NO: iW-PREPZ-02-MA-R3.0-REL1.1

MATERIAL :	WEIGHT:	In grams.
FINISH :	SUR AREA:	In sqr.mm
TITLE: HEAT SINK AND TIM ASSEMBLY	REV: 1.1	REL: 3.0
DATE : 15-05-2018	SHEET 1 OF 1	

NOTES:
ALL DIMENSIONS ARE IN MM.
ROUND OFF ALL SHARP EDGES.
SCALE: